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Item # Designator Quantity Value PartNumber Manufacturer Description PackageReference CAP, CERM, 1800 pF, 100 V, +/- 10%, X7R, 0402 C1, C3 2 1800pF GRM155R72A182KA01D MuRata 0402 1 C0603C183K1RACTU CAP, CERM, 0.018 uF, 100 V, +/- 10%, X7R, 0603 0603 2 C2 0.018uF Kemet 3 C4, C5 2 0.22uF GRM155R60J224KE01D MuRata CAP, CERM, 0.22 uF, 6.3 V, +/- 10%, X5R, 0402 0402 GRM155R72A272KA01D MuRata CAP, CERM, 2700 pF, 100 V, +/- 10%, X7R, 0402 0402 4 C6, C8 2 2700pF 5 C7 1 0.027uF C0603C273K1RACTU Kemet CAP, CERM, 0.027 uF, 100 V, +/- 10%, X7R, 0603 0603 GRM155B31A225ME95 CAP, CERM, 2.2 uF, 10 V, +/- 20%, B, 0402 0402 6 C9 2.2uF MuRata 1 CGA4J3X7S2A105K125AB CAP, CERM, 1 uF, 100 V, +/- 10%, X7S, AEC-Q200 Grade 1, 0805 C10 TDK 0805 7 1 1uF 8 C11, C13 2 150pF GRM1555C1H151JA01D MuRata CAP, CERM, 150 pF, 50 V, +/- 5%, C0G/NP0, 0402 0402 9 C15 1 0.47uF GRM155R60J474KE19D MuRata CAP. CERM. 0.47 uF. 6.3 V. +/- 10%. X5R. 0402 0402 10 C16. C17 C1005X5R0J104K CAP, CERM, 0.1uF, 6.3V, +/-10%, X5R, 0402 0402 0.1uF TDK 2 C1005X5R0J475M050BC CAP, CERM, 4.7 uF, 6.3 V, +/- 20%, X5R, 0402 0402 11 4.7uF TDK C18 1 12 D1, D2 2 40V ZHCS350TA Diodes Inc. Diode, Schottky, 40 V, 0.35 A, SOD-523 SOD-523 13 D3 Yellow LY L29K-J1K2-26-Z OSRAM LED, Yellow, SMD LED, 1.3x0.65x0.8mm 14 D5 1 Green LG L29K-G2J1-24-Z OSRAM LED, Green, SMD 1.7x0.65x0.8mm 15 J2 1 09 0431 212 04 Binder-Connector M12 Socket, 4Pos, TH M12 Conn D12x14.3 850-10-004-40-001000 Header, 50mil, 4x1, Gold, R/A, SMT 16 J3 1 Mill-Max Header, 50mil, R/A,SMT 17 R1, R3, R7, R11 4 4.12k RG1608P-4121-B-T5 Susumu Co Ltd RES, 4.12 k, 0.1%, 0.1 W, 0603 0603 18 R2 1 3.24k PFC-W1206R-12-3241-B TT Electronics/IRC RES, 3.24 k, 0.1%, 0.333 W, 1206 1206 19 R5, R6, R8 47 CRCW040247R0JNED Vishay-Dale RES, 47, 5%, 0.063 W, 0402 0402 3 R13, R14 CRCW0402820RJNED Vishay-Dale RES, 820, 5%, 0.063 W, 0402 0402 20 820 2 21 R15 47k CRCW040247K0JNED Vishay-Dale RES, 47 k, 5%, 0.063 W, 0402 0402 1 CRCW04024K70JNED Vishay-Dale RES, 4.7 k, 5%, 0.063 W, 0402 0402 22 R16 4.7k 1 RT1 100 ohm PTS120601B100RP100 Vishay/Beyschlag Temperature Sensor, 100 ohm, 1%, 1206 1206 23 1 24 S2 1 SKRKAEE010 Alps Switch, Push Button, SMD 2.9x2x3.9mm SMD 25 U1 ADS1220IRVA Texas Instruments Low-Power, Low-Noise, 24-Bit Analog-to-Digital Converter for Small RVA0016A Signal Sensors, RVA0016A 26 TIOL111 IO-Link Device Transceiver with Integrated Surge Protection, TIOL111 TIOL111 U2 Texas Instruments 1 (WSON-10) MSP430FR5738IRGE Texas Instruments 24 MHz Mixed Signal Microcontroller, 1024 B SRAM and 17 GPIOs, -40 RGE0024G 27 U3 1 to 85 deqC, RGE0024G GRM155R70J222KA01D CAP, CERM, 2200 pF, 6.3 V, +/- 10%, X7R, 0402 2200pF MuRata 0402 28 C14 0 29 R9 0 300 RG1608P-301-B-T5 Susumu Co Ltd RES, 300, 0.1%, 0.1 W, 0603 0603

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